

A Product Line of **Diodes Incorporated**

LITE-ON SEMICONDUCTOR FUS2GD(LS)

SURFACE MOUNT **REVERSE VOLTAGE** - 400 Volts **ULTRA FAST RECTIFIER** FORWARD CURRENT - 2 Amperes **FEATURES** F3-D Ultra Fast switching for high efficiency Glass passivated chip F3-D For surface mounted applications Low forward voltage drop and high current capability DIM MIN TYP MAX Low reverse leakage current 5.60 Α 4.80 5.20 Lead-Free Finish; RoHS Compliant (Notes 1 & 2) в 2.25 2.80 2.95 Halogen and Antimony Free. "Green" Device (Note 3) С 0.90 1.00 1.10 **MECHANICAL DATA** 3.95 4.20 4.60 D Package: JEDEC DO-221AC Е 1.25 1.50 1.65 Package Material: "Green" Molding compound, UL F 0.20 0.40 0.15 flammability classification 94V-0, (No Br. Sb. Cl.) 0.75 1.50 G 1.00 "Halogen-free". н 0.025 0.05 0.075 Moisture Sensitivity: Level 1 per J-STD-020C L 1.90 2.05 2.20 · Lead Free Finish, RoHS compliant Marking: FUS2GD All dimension in millimeter Weight: 0.035 grams (Approximate) MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25°C ambient temperature unless otherwise specified. **ABSOLUTE RATINGS** PARAMETER SYMBOL VALUE UNIT Maximum repetitive peak reverse voltage V_{RRM} 400 V Maximum DC blocking voltage V_{DC} 400 V 2 Maximum Average rectified forward current @Tc = 70°C I(AV) A Peak forward surge 8.3ms single half sine-wave superimposed on I_{FSM} 50 А rated load Operating and Storage temperature range -55 ~ +150 °C T_{J,} T_{STG} STATIC ELECTRICAL CHARACTERISTICS PARAMETER **TEST CONDITION** SYMBOL MAX UNIT TYP Forward voltage (Note 4) $I_F = 2A$ $T_1 = 25^{\circ}C$ VF 1.3 V $T_{.1} = 25^{\circ}C$ 5 Reverse leakage current $V_{R} = 400V$ uA I_R ---T_J=100°C 100 Typical junction capacitance (Note 5) Ст 15 pF THERMAL CHARACTERISTICS PARAMETER SYMBOL TYP UNIT R_{thJC} 40 Typical thermal resistance (Note 6, 7) °C/W R_{thJL} 30 R_{thJA} 70

DYNAMIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CONDITION	SYMBOL	MAX		UNIT
Reverse Recovery Time	I_F =0.5A , I_R =1.0A , I_{rr} =0.25A	t _{rr}	50		ns
Note:				REV. 2, Nov2021, K	SGP14

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine

(<1500ppm total Br + Cl) and <1000ppm antimony compounds.

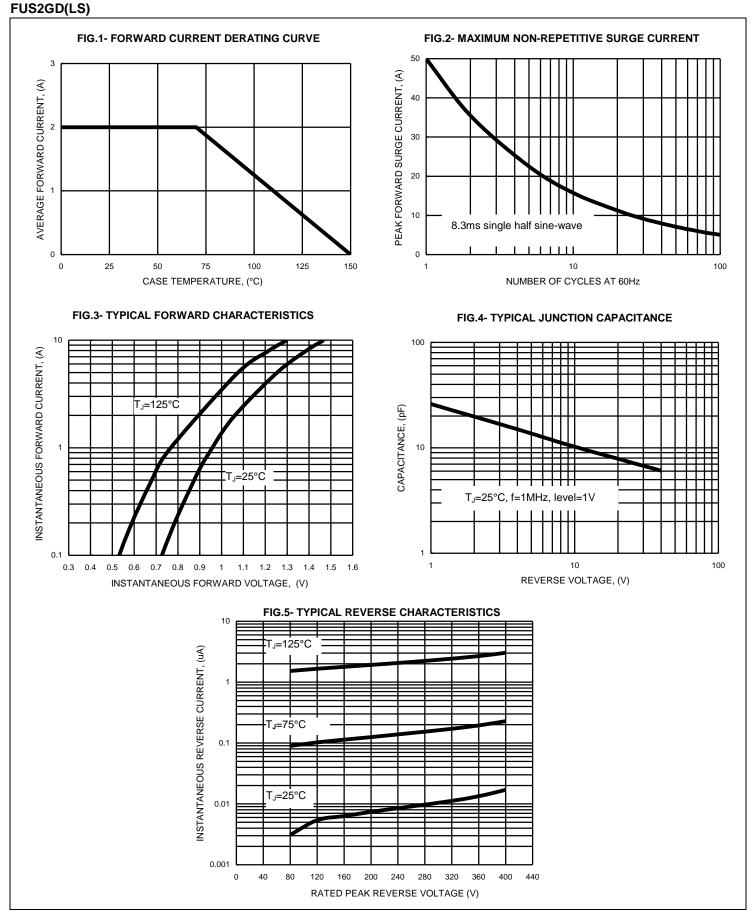
4. 300us pulse width, 2% duty cycle 5. Measured at 1.0MHz and applied reverse voltage of $4.0V_{DC}$.

6. The unit mounted on FR-4 PCB heatsink (10mm x 10mm) with 2oz copper pad

7. Thermal Resistance test performed in accordance with JESD-51

RATING AND CHARACTERISTIC CURVES

LITE-ON SEMICONDUCTOR

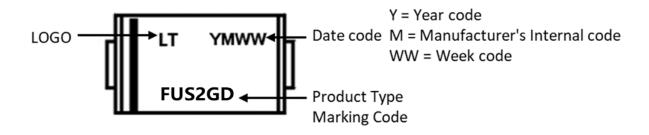




Ordering Information:

Part Number	Package	Packing	
Fait Nulliber	Fackage	Qty.	Carrier
FUS2GD_HF	F3-D	10000	Tape & Reel

Marking Information :



Packaging Information:

DEVICE	Q'TY/REEL	REEL DIA.	Q'TY/BOX	Q'TY/CARTON
	(PCS)	(INCH)	(PCS)	(PCS)
FUS2GD	10000	13	10000	120K



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